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POWER REDUCTION TECHNIQUES IN VLSI

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Abstract:

The paper investigates different level of techniques used for power reduction in VLSI. Before, most of the researches were oriented towards bringing about high speed and miniaturization. At present, because of the increasing trend of compact devices, the requirement for low power consuming circuits have also increased. This necessitates the need to align the research for reducing power dissipation in VLSI circuits. In the given paper we will briefly discuss about the different types of power reduction techniques at design abstraction level which are adopted in industries now-a-days. The comparison of traditional techniques and present techniques are also covered in this paper.

Keywords: Gating Technique; Back Biasing; FET; Multi-Threshold Devices; Power Dissipation.

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1. Introduction

With the demand of addition of more and more system on chip, the number of transistors are getting added which leads to the increase in power dissipation in the devices [1]. Two main features of low power design is battery lifeline; specially in portable devices and the other one is reliability. Power consumption in VLSI devices are of four types which are given by

- 1) Dynamic power consumption
- 2) Static power consumption
- 3) Leakage power consumption
- 4) Static power consumption

To overcome these problems, many traditional techniques are been used which are given by clock gating, power gating, variable frequency, variable voltage supply and variable device threshold. Where as many modern techniques are also been used such dynamic power reduction, leakage power reduction, back biasing and many more.

2. Low Power Design

Power loss is the main constrain when it comes to portability. Exigency for more features and extended battery life has been increased. Around 2/3 populations demands for longer stand by time as primary mobile phone feature [1][2]. Power matters in SOC because of the following concerns

- 1) Environmental concerns.
- 2) Battery life
- 3) Digital noise immunity
- 4) Packaging cost
- 5) Cooling cost

Principles of low power designs are given as

- 1) Using higher frequency device and using them in lowest possible frequency
- 2) Disconnecting the power supply when system is not in use
- 3) Controlling power dissipation at architectural level
- 4) Using pipelining and parallelism to lowest required frequency of operation Using lowest possible supply voltage

Table 1: Power Reduction Techniques

Traditional	Dynamic Power	Leakage Power Reduction	Other Power
Techniques	Reduction		Reduction Technique
Clock gating	Clock gating	Minimize usage of V _T cells	Minimize oxide devices
Variable frequency	Variable frequency	Back biasing	Power efficient circuit
Variable voltage	Variable voltage	Reduce oxide thickness	
supply	supply		
Variable device	Variable island	Use FET	
threshold			

3. Traditional Low Power Techniques

To reduce the power usage, clock frequency, reduction of switching activity, voltage scaling is very widely used.

3.1. Clock Gating

This technique is a very popular technique mainly used for the reduction of dynamic power dissipation [2]. In clock gating technique, more logic gates are added to the circuits to trim the clock tree. By paring the clock, the clock defuses some parts of the circuits so that there is no switching in the flip flops.

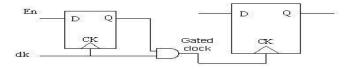


Figure 1: Latched based clock gating

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Latch based clock gating append a level sensitive latch which is designed in a way to hold the enabled signal from the active edge of the clock unless the generation of complete clock pulse.

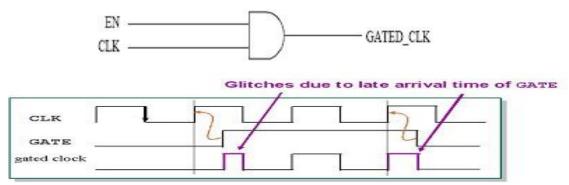


Figure 2: Latch free clock gating

AND and OR gate is used for designing latch free clock gating. If the enabled signal goes inactive between the clock pulses then gate clock either generate multiple clock pulses or can terminate prematurely.

3.2. Variable Frequency

Variable frequency drive (VFD) is also called as adjustable frequency devices. it is used in electro mechanical drive systems so to control the speed of AC motors and torque. It is been done by varying inputs given to the motors. These inputs can be frequency or voltage. VFD is use almost in every small appliance to compressors as about quarter of the electrical energy is used in industries by the motors.

By the mean of VFD, many motors application that are supplied from AC line power can save power when work at different variable.

VFD consist of following three components

- AC Motor
- Controller
- Operator interface

Main two benefits of VFD are energy saving and control performance.

3.3. Variable Voltage Supply

A regular variable voltage supplier is basically a three terminal positive voltage regulator which is used to supply different dc voltage outputs except fixed voltage power supply as shown in fig 3.

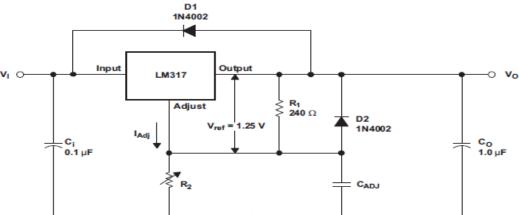


Figure 3: Variable voltage regulators

3.4. Variable Device Threshold

This technology controls the threshold voltage by substrate bias control. The investigation of the characteristics of variable threshold voltage is been done by device simulation. Thus if the threshold voltage is decreased, the drive current is increased and decrease the degradation due to the series connected configuration.

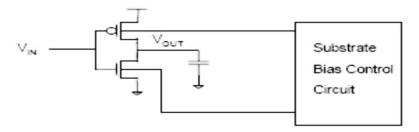


Figure 4: Variable Threshold

By adjusting the body biased voltage, as shown in fig 4, threshold voltage of both the devices can be increased, thus reducing the sub threshold voltage in standby mode.

4. Dynamic Power Reduction

Power utilization in CMOS is generally of three types, static power consumption, dynamic power consumption and leakage current .Dynamic power equation is given by:

$$P=ACV^2F$$

Dynamic power consumption is the energy consumed while charging and discharging of the capacitance. Most of the reduction in power dissipation can be controlled at architectural level. The combination of software and hardware mechanism switches down the parts which are not in use. At circuit and process level, the leakage current can be reduced more effectively.

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4.1. Clock Gating

It is mostly used in sequential circuits for reduction of dynamic power. The main principle of clock gating is that it reduces the consumption of clock signals that is switching power of flip flops [2]. By introducing clock gating, the unnecessary clock switching of the adders can be removed or avoided during clock cycles. Up to the half that is 50% or sometimes even more of dynamic power can be wasted during the clock buffering [2][3]. This is because of the higher toggle rate in the system, the cock buffers usage is more in a system and clock buffers minimize clock delay.

4.2. Power Efficient Technique

Power efficiency can be achieved by the reduction of power loss. Reducing power loss will result in the financial cost saving to consumers if the power savings offset any additional costs of implementing and power efficient technology. Power efficiency and power renewal are two pillars of sustainable power. Power can be analyze at circuit and gate level. There are certain techniques for low power

4.2.1. Adiabatic Circuits

The principle of adiabatic circuits is that they reuse the power instead of dissipating. This is done by restraining the shape and length of the signal transition energy. Because of the thermodynamically invisible nature, diodes are not used in the designing of the adiabatic circuits.

4.2.2. Logic Design of Low Power

In static CMOS circuit, the power dissipation is about 10% of the total power consumption. in dynamic circuits, as there is no direct dc supply to ground, we don't face such problem but in domino – logic circuits, there is direct path from supply voltage to ground, so there is short circuit power dissipation [Fig5].

Figure 5: Static NOR

Z can only be pulled up id A=B=0V Z can be pulled down by either A=1 or B=1 (or both)

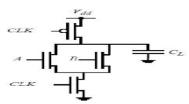


Figure 6: Dynamic NOR

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5. Leakage Power Reduction

In on-chip devices, leakage power reduction has become very challenging. Decrease of the threshold voltage current has resulted in the increase of the subthreshold leakage current thus increase the leakage power dissipation [3]. Subthreshold leakage current is given as the drain to source current of a transistor operating in the weak inversion region. Dependence of device parameters on subthreshold leakage current is given in following table.

14010 21 2 40 0 0 0 10 10 20 0 0 0 11 0 10		
RAMETERS	DEPENDENCE	
mperature (T)	Exponential increase	

PA Ter Transistor length (L) Inversely proportional Transistor width (W) Directly proportional Input voltage (V_{gs}) Exponential increase

Increase by the order of magnitude with 100mv decrease

Table 2: Subthreshold Leakage Current

5.1. Use of Low Vt Cell and High Vt Cell

 $\overline{\text{Transistor threshold voltage }}(V_{th})$

For reducing power while maintain speed, multiple V_t devices are used. low V_t devices are used for designing high circuit path, on other hand high V_t is applied to gates in order to reduce leakage current .Multiple threshold technique is mostly been taken into consideration because it does not require any change in SOC architecture ,it instead depends on how the designer judiciously use low V_t cell[4]. The advantage of low V_t cell is that it has low timing but higher leakage current and high V_t cells have low leakage current but high timing as shown in fig7. So as high Vt cells have more timing so they are used where timing is relaxed where as low V_t cells are used at time-critical places [5].

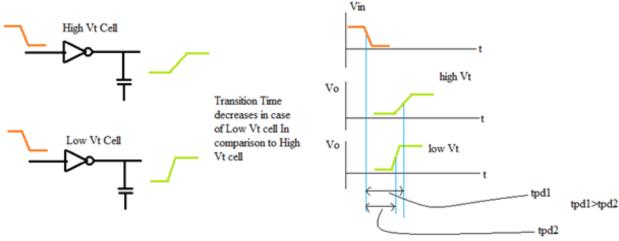


Figure 7: High and Low V_t cell

5.2. Back Biasing

This method is used to produce biased voltage. This method is used to produce negative biased supply easily for an amplifier which use a full wave center tapped rectifier, either in solid state or [Sharma et. al., Vol.5 (Iss.2: SE): February, 2018] ISSN: 2454-1907 [Communication, Integrated Networks & Signal Processing-CINSP 2018] DOI: 10.5281/zenodo.1200290 in tube state. Back biasing is also known as substrate biasing [6]. With the improvement in the techniques, the substrate is biased to increase transistor threshold. Thus thereby minimizing leakage. In PMOS, the body of transistor is biased to a voltage higher than V_{dd}. In NMOS, the

body of transistor is biased to a voltage lower than V_{ss}.

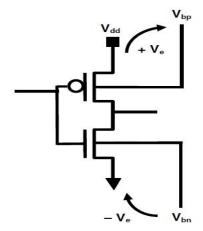


Figure 8: Body Biasing

6. Conclusion

Power reduction at various levels of abstraction, namely the circuit, logic, architecture and system level is been estimated .power consumption diffusion among clock distribution, memories, gates, interconnections are analyzed. Lowering power dissipation at every abstraction level is at focal point of industrial research.

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